



Description

The TA2002 SISO Power Amplifier is a class AB GaN module with an operating frequency range of 2200 to 2500 MHz. Designed for both military and commercial applications, this amplifier features an input voltage range of +10 to +30 VDC and a saturated RF output power of +40 dBm. With the capability of supporting any signal type and modulation format, all in a low-SWaP package, this unit is ideal for applications where high power-density, efficiency, and linearity are key.

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Features

- Under Voltage Protection
- Temperature Monitor Output
- Over-Temperature Protection
- Amplifier Status Output

Applications

- Military or Commercial Radio Systems
- Unmanned Systems
- Vehicle Systems
- Aircraft Systems
- Fixed Site Infrastructure

CHARACTERISTICS & SPECIFICATIONS

Specifications subject to change without notice. Typical performance at 28VDC at 25°C in a 50Ω system.

Tx Specifications (Per Channel)

Parameter	Min.	Typ.	Max	Unit
Operating Frequency	2200	—	2500	MHz
64QAM Power Output 20 MHz BW, -27 dB EVM Limit	33	—	—	dBm
BPSK Power Output 20 MHz BW, -7 dB EVM Limit	40	—	—	dBm
Saturated Power Output CW Sweep at Design Limit	—	40	—	dBm
Small Signal Gain	24	27	—	dB
Small Signal Gain Flatness	—	—	2	dB (peak to peak)
Input Return Loss	—	—	-12	dB
Tx Switching Time	—	1	2	μS

Power Supply Specifications

Parameter	Min.	Typ.	Max	Unit	Notes
Supply Voltage Range	10	28	30	VDC	—
RMS Operating Current Draw (Idle)	—	0.2	—	A	VDC Supply Voltage, Idle in Receive Mode
RMS Operating Current Draw (64QAM Power Output)	—	0.7	—	A	28VDC Supply Voltage, 802.11 WLAN Signal, 50% Duty Cycle
RMS Operating Current Draw (BPSK Power Output)	—	1	—	A	28VDC Supply Voltage, 802.11 WLAN Signal, 50% Duty Cycle

Mechanical Specifications

Parameter	Value	Unit
Dimensions (L x W x H)	2.3 x 2.3 x 0.45 (58.4 x 58.4 x 11.4)	in (mm)
Cooling	Baseplate Conduction	—
Weight	3 (85)	oz (g)

CHARACTERISTICS & SPECIFICATIONS (CONT.)

Specifications subject to change without notice.

Interface Specifications

Parameter	Value	Notes
RF Connectors (Input / Output)	SMP-M / SMP-M	—
Power / Signal Connector	M80-8671222	Connector appearing on unit (Manufacturer P/N)
Mating Connector	M80-8881205	Mating connector required for interfacing (Manufacturer P/N)
Test Integration Cable	CBL64	Triad P/N available for purchase separately

Environmental Specifications

Parameter	Min.	Max	Unit
Operating Temperature (Housing Temp.)	-40	85	°C
Storage Temperature	-55	85	°C
Altitude	0 (0)	30000 (9144)	ft. (m.)
Ingress Protection Rating	IP40		—
Shock / Vibration	Designed to comply with MIL-STD-810 Shock / Vibration Test Methods		—

Protections and Maximum Ratings

Parameter	Value	Unit	Notes
Maximum RF Input (Per Channel)	30	dBm	CW Power
Over Temp Protection Trip Level	85	°C	Internally Monitored System Temperature
RF Output Open Load Survivability	40	dBm	CW with Open Circuit at Antenna Port

DC / CONTROL CONNECTOR

Input and Output Pins

TTRM Connector Part Number			Mating Connector Part Number	
M80-8671222			M80-8881205	
Pin	Label	Type	I/O	Notes
1	VDC	Power	Input	Supply Voltage - Range Specified in Data Sheet
2	VDC	Power	Input	Supply Voltage - Range Specified in Data Sheet
3	VDC	Power	Input	Supply Voltage - Range Specified in Data Sheet
4	TEMP	Signal	Output	Temperature Monitor Temp in DegC = (Vout - 0.5V) * 100
5	N/C	N/A	N/A	Not Connected
6	Tx/Rx Status	Signal	Output	BDA Operational State TTL High = Tx Amp Active TTL Low = Rx Amp Active
7	I/O	Signal	Input	TA: TTL High or No Connection = Enable TTL Low = Disable Manual Switching TTRM: TTL High = Tx Amp Enabled TTL Low = Rx Amp Enabled Automatic Switching TTRM: Pin not required. Do not use.
8	Bypass	Signal	Input	Bypass Control TTL High or Open = Amplifier Mode GND = Bypass
9	Amp Status	Signal	Output	BDA Status TTL High = Normal Operation TTL Low = Error Condition
10	GND	Power	Input	Supply Voltage Return (Ground)
11	GND	Power	Input	Supply Voltage Return (Ground)
12	GND	Power	Input	Supply Voltage Return (Ground)

Note: All +VDC and GND pins should be populated as shown.

MECHANICAL DRAWING

